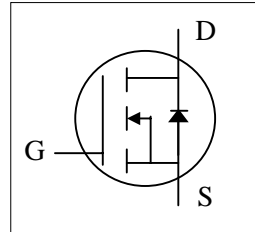




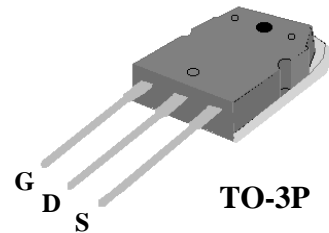
- ▼ Low On-resistance
- ▼ Simple Drive Requirement
- ▼ Fast Switching Characteristic



BV_{DSS}	500V
$R_{DS(ON)}$	0.43 Ω
I_D	16A

Description

The Advanced Power MOSFETs from APEC provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	500	V
V_{GS}	Gate-Source Voltage	± 30	V
$I_D @ T_C = 25^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$	16	A
$I_D @ T_C = 100^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$	11	A
I_{DM}	Pulsed Drain Current ¹	64	A
$P_D @ T_C = 25^\circ C$	Total Power Dissipation	208	W
E_{AS}	Single Pulse Avalanche Energy ²	159	mJ
I_{AR}	Avalanche Current	16	A
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ C$
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ C$

Thermal Data

Symbol	Parameter	Value	Units
Rthj-c	Thermal Resistance Junction-case	Max. 0.6	$^\circ C/W$
Rthj-a	Thermal Resistance Junction-ambient	Max. 40	$^\circ C/W$



AP4085W

Electrical Characteristics @T_j=25°C(unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =1mA	500	-	-	V
R _{DS(ON)}	Static Drain-Source On-Resistance ³	V _{GS} =10V, I _D =8A	-	-	0.43	Ω
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250uA	3	-	5	V
g _{fs}	Forward Transconductance	V _{DS} =10V, I _D =8A	-	6.3	-	S
I _{DSS}	Drain-Source Leakage Current	V _{DS} =400V, V _{GS} =0V	-	-	100	uA
I _{GSS}	Gate-Source Leakage	V _{GS} =±30V	-	-	±100	nA
Q _g	Total Gate Charge ³	I _D =16A	-	48	77	nC
Q _{gs}	Gate-Source Charge	V _{DS} =200V	-	9	-	nC
Q _{gd}	Gate-Drain ("Miller") Charge	V _{GS} =10V	-	32	-	nC
t _{d(on)}	Turn-on Delay Time ³	V _{DD} =200V	-	48	-	ns
t _r	Rise Time	I _D =8A	-	134	-	ns
t _{d(off)}	Turn-off Delay Time	R _G =50Ω, V _{GS} =10V	-	195	-	ns
t _f	Fall Time	R _D =25Ω	-	121	-	ns
C _{iss}	Input Capacitance	V _{GS} =0V	-	1205	1930	pF
C _{oss}	Output Capacitance	V _{DS} =30V	-	255	-	pF
C _{rss}	Reverse Transfer Capacitance	f=1.0MHz	-	50	-	pF

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V _{SD}	Forward On Voltage ³	I _S =16A, V _{GS} =0V	-	-	1.3	V
t _{rr}	Reverse Recovery Time	I _S =16A, V _{GS} =0V	-	630	-	ns
Q _{rr}	Reverse Recovery Charge	di/dt=100A/μs	-	13	-	uC

Notes:

- 1.Pulse width limited by Max junction temperature.
- 2.Starting T_j=25°C , V_{DD}=99V , L=1mH , R_G=25Ω
- 3.Pulse test

THIS PRODUCT IS ELECTROSTATIC SENSITIVE, PLEASE HANDLE WITH CAUTION.

THIS PRODUCT HAS BEEN QUALIFIED FOR USE IN CONSUMER APPLICATIONS. APPLICATIONS OR USE IN LIFE SUPPORT OR OTHER SIMILAR MISSION-CRITICAL DEVICES OR SYSTEMS ARE NOT AUTHORIZED.

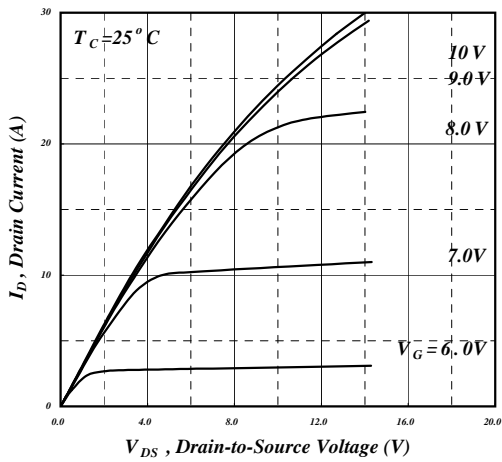


Fig 1. Typical Output Characteristics

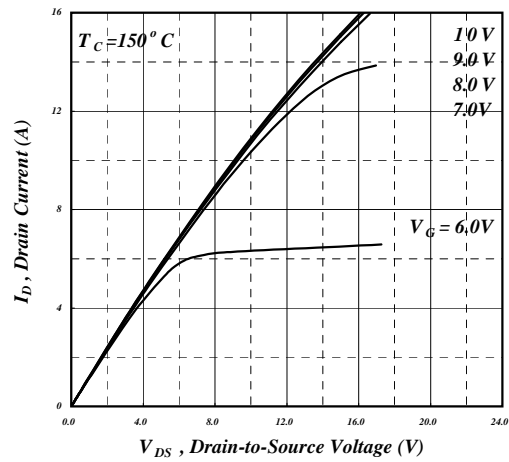


Fig 2. Typical Output Characteristics

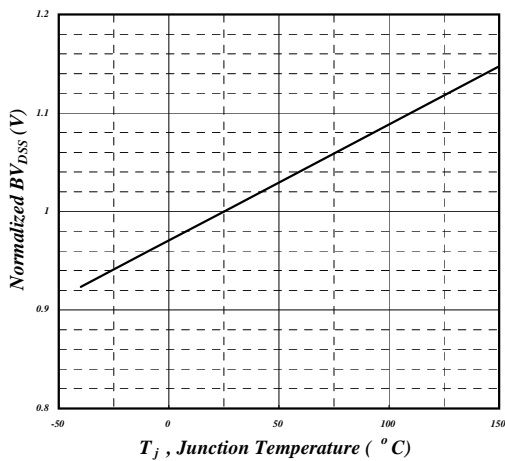


Fig 3. Normalized BV_{DSS} v.s. Junction Temperature

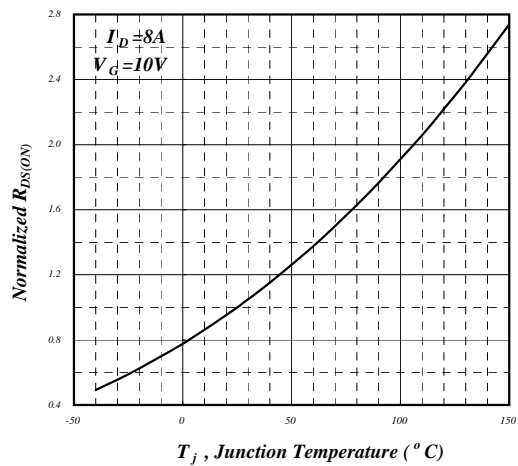


Fig 4. Normalized On-Resistance v.s. Junction Temperature

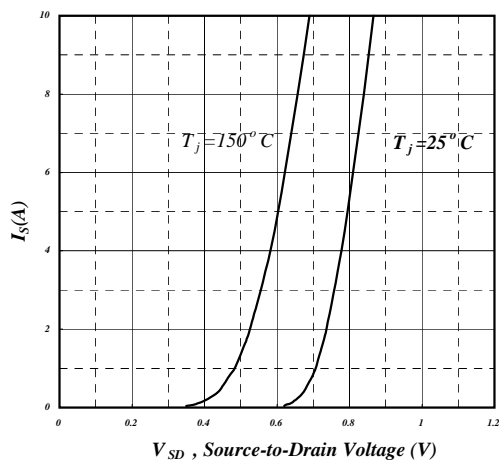


Fig 5. Forward Characteristic of Reverse Diode

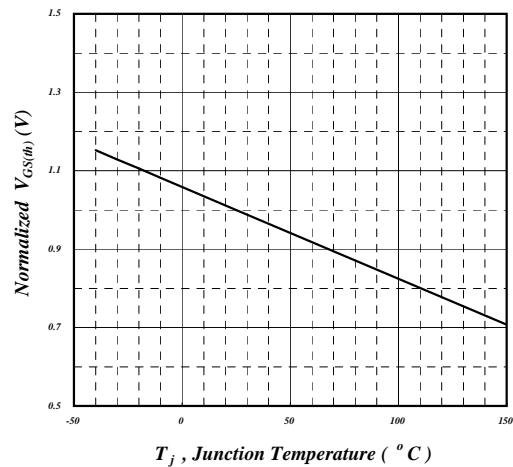


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

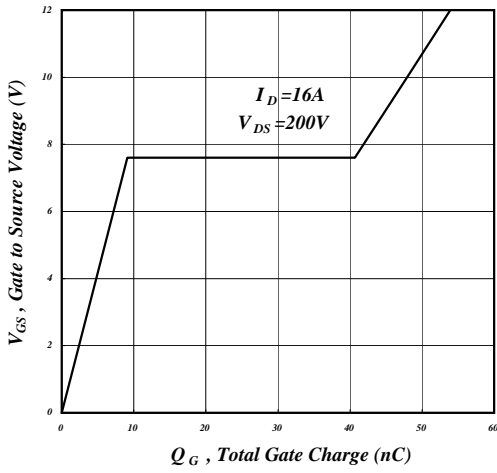


Fig 7. Gate Charge Characteristics

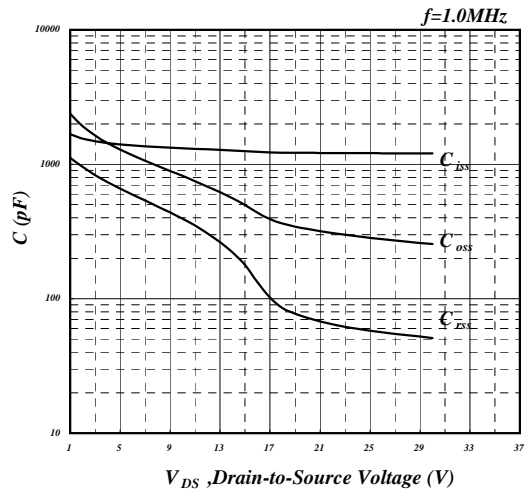


Fig 8. Typical Capacitance Characteristics

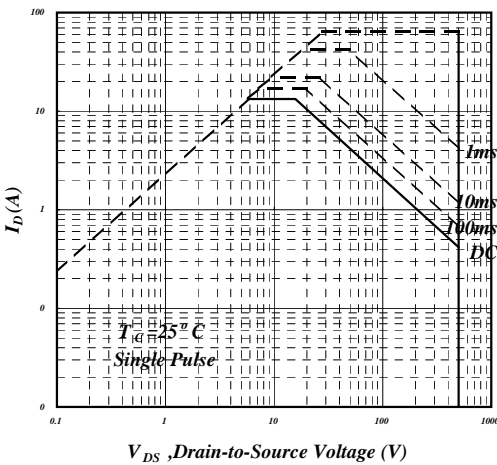


Fig 9. Maximum Safe Operating Area

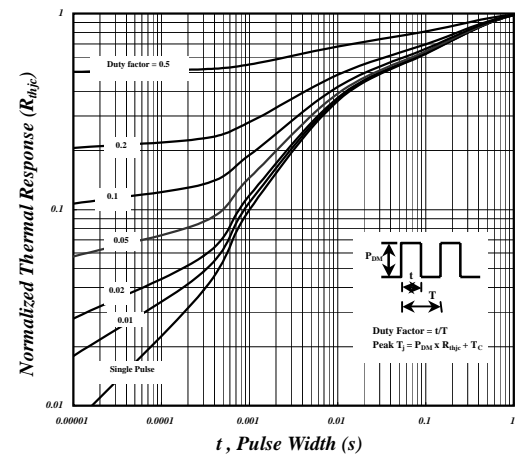


Fig 10. Effective Transient Thermal Impedance

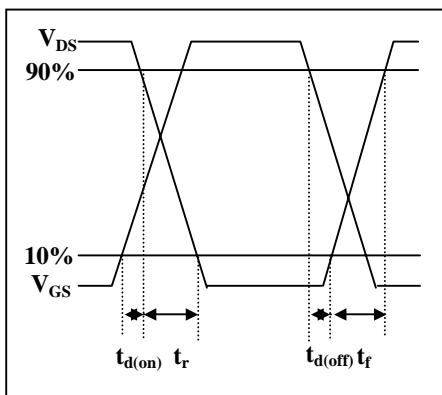


Fig 11. Switching Time Waveform

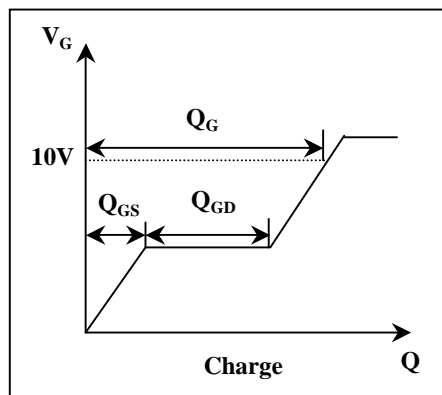
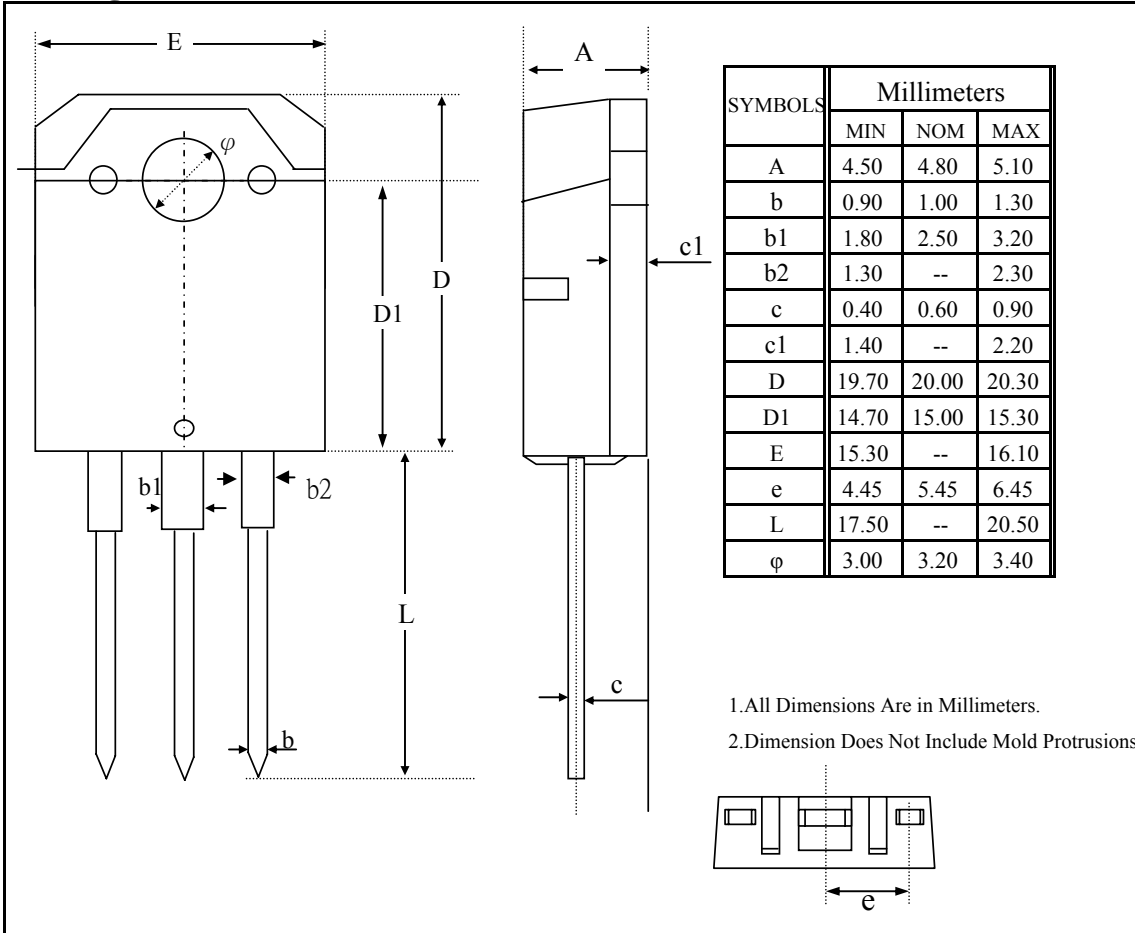


Fig 12. Gate Charge Waveform



Package Outline : TO-3P



Part Marking Information & Packing : TO-3P

